

3.2mmx1.6mm SMD CHIP LED LAMP

Part Number: APT3216ZGC/E



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE

DEVICES

Features

- 3.2mmx1.6mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Green source color devices are made with InGaN Light Emitting Diode.

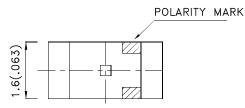
Green

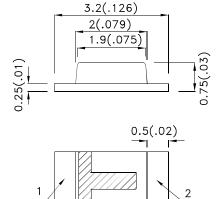
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

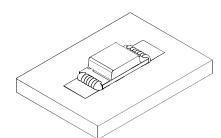
All devices, equipment and machinery must be electrically grounded.

Package Dimensions









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAJ9205 **REV NO: V.2** DATE: DEC/31/2009 PAGE: 1 OF 5 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: J.Yu ERP: 1203009953

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
APT3216ZGC/E	Green (InGaN)	WATER CLEAR	280	650	120°

Notes

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	IF=20mA
С	Capacitance	Green	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	4	V	I=20mA
lR	Reverse Current	Green		10	uA	V _R =5V

Notes:

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

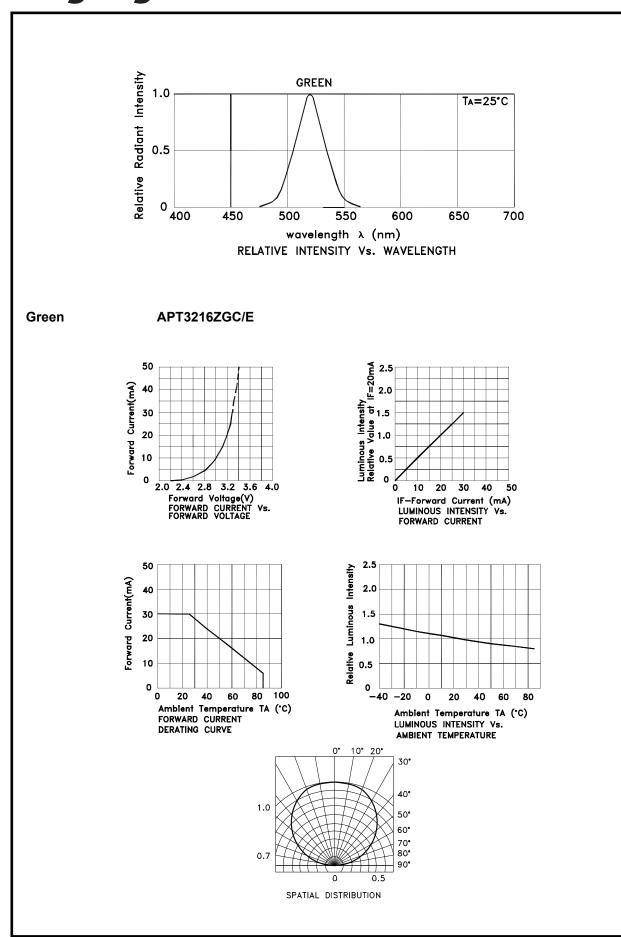
Parameter	Green	Units		
Power dissipation	120	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	100	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

 SPEC NO: DSAJ9205
 REV NO: V.2
 DATE: DEC/31/2009
 PAGE: 2 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: J.Yu
 ERP: 1203009953



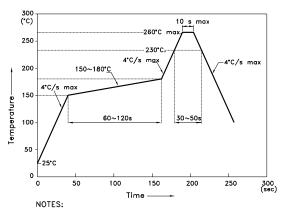
 SPEC NO: DSAJ9205
 REV NO: V.2
 DATE: DEC/31/2009
 PAGE: 3 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: J.Yu
 ERP: 1203009953

APT3216ZGC/E

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

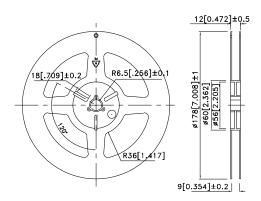
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

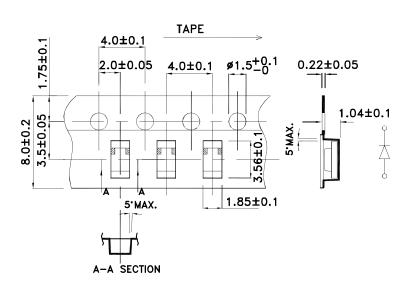
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

1.75 2.0 1.75

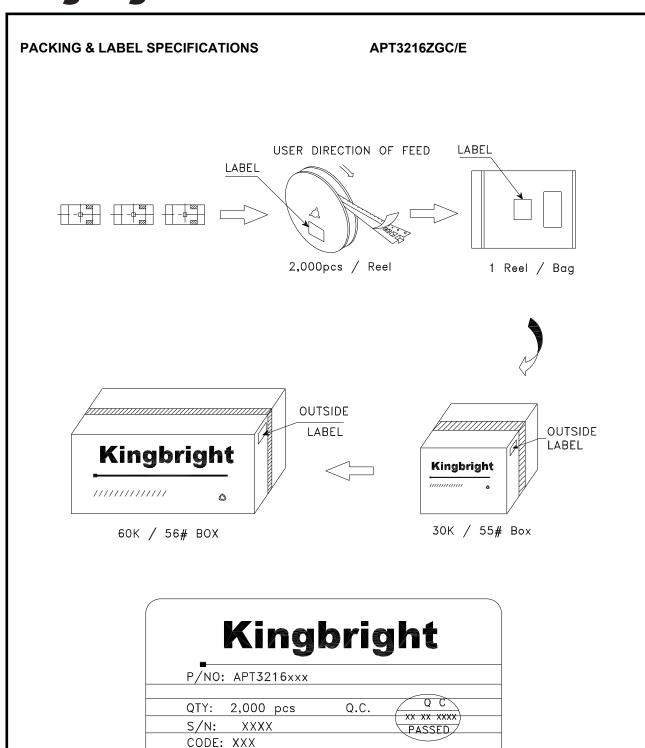
Reel Dimension



Tape Dimensions (Units: mm)



SPEC NO: DSAJ9205 **REV NO: V.2 DATE: DEC/31/2009** PAGE: 4 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1203009953



SPEC NO: DSAJ9205 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu

LOT NO:

DATE: DEC/31/2009 DRAWN: J.Yu

RoHS Compliant

PAGE: 5 OF 5 ERP: 1203009953